

S-1004 Series

BUILT-IN DELAY CIRCUIT (EXTERNAL DELAY TIME SETTING) VOLTAGE DETECTOR WITH SENSE PIN

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Rev.2.1_02

The S-1004 Series is a high-accuracy voltage detector developed using CMOS technology. The detection voltage is fixed internally with an accuracy of $\pm 1.0\%$ ($-V_{DET(S)} \ge 2.2$ V). It operates with current consumption of 500 nA typ.

Apart from the power supply pin, the detection voltage input pin (SENSE pin) is also prepared, so the output is stable even if the SENSE pin falls to 0 V.

The release signal can be delayed by setting a capacitor externally, and the release delay time accuracy at Ta = $+25^{\circ}$ C is $\pm 15\%$.

Two output forms Nch open-drain output and CMOS output are available.

Features

- Detection voltage: 1.0 V to 5.0 V (0.1 V step)
- Detection voltage accuracy: $\pm 1.0\%$ (2.2 V $\leq -V_{\text{DET}(S)} \leq 5.0$ V)
 - $\pm 22 \text{ mV} (1.0 \text{ V} \le -V_{\text{DET}(S)} < 2.2 \text{ V})$
- Current consumption:
- Operation voltage range:
- Hysteresis width:
- Release delay time accuracy:
- Output form: Nch open-drain output (Active "L")
 - CMOS output (Active "L")
- Operation temperature range: Ta = -40° C to $+85^{\circ}$ C
- Lead-free (Sn 100%), halogen-free

Applications

- Power supply monitor for microcomputer and reset for CPU
- · Constant voltage power supply monitor for TV, Blu-ray recorder and home appliance

500 nA typ.

5% ± 2%

0.95 V to 10.0 V

• Power supply monitor for portable devices such as notebook PC, digital still camera and mobile phone

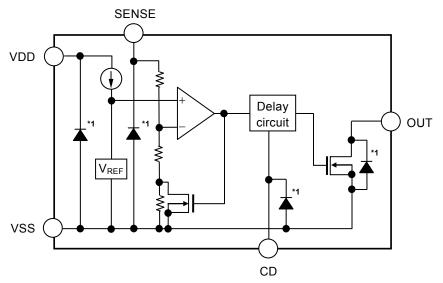
 $\pm 15\%$ (C_D = 4.7 nF, Ta = $\pm 25^{\circ}$ C)

Packages

- SOT-23-5
- SNT-6A

Block Diagrams

1. S-1004 Series NA / NB type (Nch open-drain output)

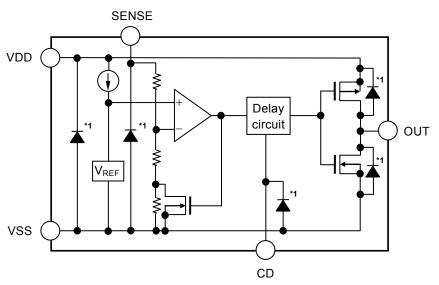


Function	Status
Output logic	Active "L"

*1. Parasitic diode

Figure 1

2. S-1004 Series CA / CB type (CMOS output)



Function	Status
Output logic	Active "L"

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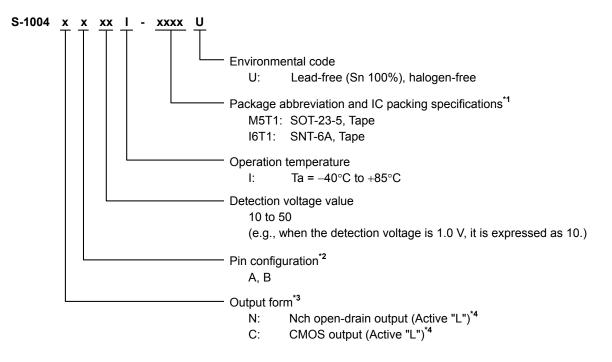
*1. Parasitic diode

Figure 2

Product Name Structure

Users can select the output form and detection voltage value for the S-1004 Series. Refer to "1. Product name" regarding the contents of product name, "2. Function list of product types" regarding the product types, "3. Packages" regarding the package drawings and "4. Product name list" regarding details of product name.

1. Product name



- *1. Refer to the tape drawing.
- *2. Refer to "■ Pin Configurations".
- *3. Refer to "2. Function list of product types".
- *4. If you request the product with output logic active "H", contact our sales office.

2. Function list of product types

Table 1

Product Type	Output Form	Output Logic	Pin Configuration	Package
NA	Neb open drein eutrut	Active "L"	А	SOT-23-5, SNT-6A
NB	Nch open-drain output	Active "L"	В	SOT-23-5
CA	CMOS output	Active "L"	А	SOT-23-5, SNT-6A
СВ		Active "L"	В	SOT-23-5

3. Packages

Table 2 Packa	ge Drawing	Codes
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Package Name	Dimension	Таре	Reel	Land
SOT-23-5	MP005-A-P-SD	MP005-A-C-SD	MP005-A-R-SD	_
SNT-6A	PG006-A-P-SD	PG006-A-C-SD	PG006-A-R-SD	PG006-A-L-SD

4. Product name list

4.1 S-1004 Series NA type

Output form: Nch open-drain output (Active "L")

Table 3			
Detection Voltage	SOT-23-5	SNT-6A	
$1.0 \text{ V} \pm 22 \text{ mV}$	S-1004NA10I-M5T1U	S-1004NA10I-I6T1U	
$1.1 \text{ V} \pm 22 \text{ mV}$	S-1004NA11I-M5T1U	S-1004NA11I-I6T1U	
$1.2 \text{ V} \pm 22 \text{ mV}$	S-1004NA12I-M5T1U	S-1004NA12I-I6T1U	
$1.3 \text{ V} \pm 22 \text{ mV}$	S-1004NA13I-M5T1U	S-1004NA13I-I6T1U	
$1.4 \text{ V} \pm 22 \text{ mV}$	S-1004NA14I-M5T1U	S-1004NA14I-I6T1U	
$1.5 \text{ V} \pm 22 \text{ mV}$	S-1004NA15I-M5T1U	S-1004NA15I-I6T1U	
$1.6 \text{ V} \pm 22 \text{ mV}$	S-1004NA16I-M5T1U	S-1004NA16I-I6T1U	
$1.7 \text{ V} \pm 22 \text{ mV}$	S-1004NA17I-M5T1U	S-1004NA17I-I6T1U	
$1.8 \text{ V} \pm 22 \text{ mV}$	S-1004NA18I-M5T1U	S-1004NA18I-I6T1U	
$1.9 \text{ V} \pm 22 \text{ mV}$	S-1004NA19I-M5T1U	S-1004NA19I-I6T1U	
$2.0~V\pm22~mV$	S-1004NA20I-M5T1U	S-1004NA20I-I6T1U	
$2.1~V\pm22~mV$	S-1004NA21I-M5T1U	S-1004NA21I-I6T1U	
$2.2~V\pm1.0\%$	S-1004NA22I-M5T1U	S-1004NA22I-I6T1U	
$2.3~V\pm1.0\%$	S-1004NA23I-M5T1U	S-1004NA23I-I6T1U	
$2.4~V\pm1.0\%$	S-1004NA24I-M5T1U	S-1004NA24I-I6T1U	
$2.5~V\pm1.0\%$	S-1004NA25I-M5T1U	S-1004NA25I-I6T1U	
$2.6~V\pm1.0\%$	S-1004NA26I-M5T1U	S-1004NA26I-I6T1U	
$2.7~V\pm1.0\%$	S-1004NA27I-M5T1U	S-1004NA27I-I6T1U	
$2.8~V\pm1.0\%$	S-1004NA28I-M5T1U	S-1004NA28I-I6T1U	
$2.9~V\pm1.0\%$	S-1004NA29I-M5T1U	S-1004NA29I-I6T1U	
$3.0~V\pm1.0\%$	S-1004NA30I-M5T1U	S-1004NA30I-I6T1U	
$3.1~V\pm1.0\%$	S-1004NA31I-M5T1U	S-1004NA31I-I6T1U	
3.2 V ± 1.0%	S-1004NA32I-M5T1U	S-1004NA32I-I6T1U	
3.3 V ± 1.0%	S-1004NA33I-M5T1U	S-1004NA33I-I6T1U	
$3.4~V\pm1.0\%$	S-1004NA34I-M5T1U	S-1004NA34I-I6T1U	
$3.5~V\pm1.0\%$	S-1004NA35I-M5T1U	S-1004NA35I-I6T1U	
$3.6~V\pm1.0\%$	S-1004NA36I-M5T1U	S-1004NA36I-I6T1U	
3.7 V ± 1.0%	S-1004NA37I-M5T1U	S-1004NA37I-I6T1U	
3.8 V ± 1.0%	S-1004NA38I-M5T1U	S-1004NA38I-I6T1U	
3.9 V ± 1.0%	S-1004NA39I-M5T1U	S-1004NA39I-I6T1U	
4.0 V ± 1.0%	S-1004NA40I-M5T1U	S-1004NA40I-I6T1U	
$4.1 \text{ V} \pm 1.0\%$	S-1004NA41I-M5T1U	S-1004NA41I-I6T1U	
$4.2 \text{ V} \pm 1.0\%$	S-1004NA42I-M5T1U	S-1004NA42I-I6T1U	
4.3 V ± 1.0%	S-1004NA43I-M5T1U	S-1004NA43I-I6T1U	
$4.4 \text{ V} \pm 1.0\%$	S-1004NA44I-M5T1U	S-1004NA44I-I6T1U	
$4.5 \text{ V} \pm 1.0\%$	S-1004NA45I-M5T1U	S-1004NA45I-I6T1U	
4.6 V ± 1.0%	S-1004NA46I-M5T1U	S-1004NA46I-I6T1U	
$4.7~V\pm1.0\%$	S-1004NA47I-M5T1U	S-1004NA47I-I6T1U	
4.8 V ± 1.0%	S-1004NA48I-M5T1U	S-1004NA48I-I6T1U	
$4.9~V\pm1.0\%$	S-1004NA49I-M5T1U	S-1004NA49I-I6T1U	
$5.0~V\pm1.0\%$	S-1004NA50I-M5T1U	S-1004NA50I-I6T1U	

4. 2 S-1004 Series NB type

Output form: Nch open-drain output (Active "L")

	Table 4
Detection Voltage	SOT-23-5
$1.0~V\pm22~mV$	S-1004NB10I-M5T1U
$1.1 \text{ V} \pm 22 \text{ mV}$	S-1004NB11I-M5T1U
$1.2 \text{ V} \pm 22 \text{ mV}$	S-1004NB12I-M5T1U
1.3 V ± 22 mV	S-1004NB13I-M5T1U
1.4 V ± 22 mV	S-1004NB14I-M5T1U
1.5 V ± 22 mV	S-1004NB15I-M5T1U
$1.6 \text{ V} \pm 22 \text{ mV}$	S-1004NB16I-M5T1U
$1.7 \text{ V} \pm 22 \text{ mV}$	S-1004NB17I-M5T1U
$1.8~V\pm22~mV$	S-1004NB18I-M5T1U
$1.9~V\pm22~mV$	S-1004NB19I-M5T1U
$2.0~V\pm22~mV$	S-1004NB20I-M5T1U
$2.1~V\pm22~mV$	S-1004NB21I-M5T1U
$2.2~V\pm1.0\%$	S-1004NB22I-M5T1U
$2.3~V\pm1.0\%$	S-1004NB23I-M5T1U
$2.4~V\pm1.0\%$	S-1004NB24I-M5T1U
$2.5~V\pm1.0\%$	S-1004NB25I-M5T1U
$2.6~V\pm1.0\%$	S-1004NB26I-M5T1U
$2.7~V\pm1.0\%$	S-1004NB27I-M5T1U
$2.8~V\pm1.0\%$	S-1004NB28I-M5T1U
$2.9~V\pm1.0\%$	S-1004NB29I-M5T1U
$3.0~V\pm1.0\%$	S-1004NB30I-M5T1U
$3.1~V\pm1.0\%$	S-1004NB31I-M5T1U
$3.2~V\pm1.0\%$	S-1004NB32I-M5T1U
$3.3~V\pm1.0\%$	S-1004NB33I-M5T1U
$3.4~V\pm1.0\%$	S-1004NB34I-M5T1U
$3.5~V\pm1.0\%$	S-1004NB35I-M5T1U
$3.6~V\pm1.0\%$	S-1004NB36I-M5T1U
3.7 V ± 1.0%	S-1004NB37I-M5T1U
3.8 V ± 1.0%	S-1004NB38I-M5T1U
$3.9 \text{ V} \pm 1.0\%$	S-1004NB39I-M5T1U
$4.0 \text{ V} \pm 1.0\%$	S-1004NB40I-M5T1U
$4.1 \text{ V} \pm 1.0\%$	S-1004NB41I-M5T1U
$4.2 \text{ V} \pm 1.0\%$	S-1004NB42I-M5T1U
$4.3 \text{ V} \pm 1.0\%$	S-1004NB43I-M5T1U
$4.4~V\pm1.0\%$	S-1004NB44I-M5T1U
$4.5~V\pm1.0\%$	S-1004NB45I-M5T1U
$4.6~V\pm1.0\%$	S-1004NB46I-M5T1U
4.7 V ± 1.0%	S-1004NB47I-M5T1U
4.8 V ± 1.0%	S-1004NB48I-M5T1U
$4.9~V\pm1.0\%$	S-1004NB49I-M5T1U
$5.0~V\pm1.0\%$	S-1004NB50I-M5T1U

4.3 S-1004 Series CA type

Output form: CMOS output (Active "L")

	Table 5	
Detection Voltage	SOT-23-5	SNT-6A
$1.0~V\pm22~mV$	S-1004CA10I-M5T1U	S-1004CA10I-I6T1U
$1.1~V\pm22~mV$	S-1004CA11I-M5T1U	S-1004CA11I-I6T1U
$1.2~V\pm22~mV$	S-1004CA12I-M5T1U	S-1004CA12I-I6T1U
$1.3~V\pm22~mV$	S-1004CA13I-M5T1U	S-1004CA13I-I6T1U
$1.4~V\pm22~mV$	S-1004CA14I-M5T1U	S-1004CA14I-I6T1U
$1.5~V\pm22~mV$	S-1004CA15I-M5T1U	S-1004CA15I-I6T1U
$1.6~V\pm22~mV$	S-1004CA16I-M5T1U	S-1004CA16I-I6T1U
$1.7 \text{ V} \pm 22 \text{ mV}$	S-1004CA17I-M5T1U	S-1004CA17I-I6T1U
$1.8~V\pm22~mV$	S-1004CA18I-M5T1U	S-1004CA18I-I6T1U
$1.9~V\pm22~mV$	S-1004CA19I-M5T1U	S-1004CA19I-I6T1U
$2.0~V\pm22~mV$	S-1004CA20I-M5T1U	S-1004CA20I-I6T1U
$2.1~V\pm22~mV$	S-1004CA21I-M5T1U	S-1004CA21I-I6T1U
2.2 V ± 1.0%	S-1004CA22I-M5T1U	S-1004CA22I-I6T1U
$2.3~V\pm1.0\%$	S-1004CA23I-M5T1U	S-1004CA23I-I6T1U
2.4 V ± 1.0%	S-1004CA24I-M5T1U	S-1004CA24I-I6T1U
$2.5~V\pm1.0\%$	S-1004CA25I-M5T1U	S-1004CA25I-I6T1U
$2.6~V\pm1.0\%$	S-1004CA26I-M5T1U	S-1004CA26I-I6T1U
$2.7~V\pm1.0\%$	S-1004CA27I-M5T1U	S-1004CA27I-I6T1U
$2.8~V\pm1.0\%$	S-1004CA28I-M5T1U	S-1004CA28I-I6T1U
2.9 V ± 1.0%	S-1004CA29I-M5T1U	S-1004CA29I-I6T1U
3.0 V ± 1.0%	S-1004CA30I-M5T1U	S-1004CA30I-I6T1U
$3.1~V\pm1.0\%$	S-1004CA31I-M5T1U	S-1004CA31I-I6T1U
$3.2 \text{ V} \pm 1.0\%$	S-1004CA32I-M5T1U	S-1004CA32I-I6T1U
$3.3~V\pm1.0\%$	S-1004CA33I-M5T1U	S-1004CA33I-I6T1U
$3.4~V\pm1.0\%$	S-1004CA34I-M5T1U	S-1004CA34I-I6T1U
$3.5~V\pm1.0\%$	S-1004CA35I-M5T1U	S-1004CA35I-I6T1U
3.6 V ± 1.0%	S-1004CA36I-M5T1U	S-1004CA36I-I6T1U
$3.7~V\pm1.0\%$	S-1004CA37I-M5T1U	S-1004CA37I-I6T1U
$3.8~V\pm1.0\%$	S-1004CA38I-M5T1U	S-1004CA38I-I6T1U
3.9 V ± 1.0%	S-1004CA39I-M5T1U	S-1004CA39I-I6T1U
$4.0 \text{ V} \pm 1.0\%$	S-1004CA40I-M5T1U	S-1004CA40I-I6T1U
$4.1 \text{ V} \pm 1.0\%$	S-1004CA41I-M5T1U	S-1004CA41I-I6T1U
$4.2 \text{ V} \pm 1.0\%$	S-1004CA42I-M5T1U	S-1004CA42I-I6T1U
$4.3 \text{ V} \pm 1.0\%$	S-1004CA43I-M5T1U	S-1004CA43I-I6T1U
$4.4~V\pm1.0\%$	S-1004CA44I-M5T1U	S-1004CA44I-I6T1U
$4.5~V\pm1.0\%$	S-1004CA45I-M5T1U	S-1004CA45I-I6T1U
$4.6~V\pm1.0\%$	S-1004CA46I-M5T1U	S-1004CA46I-I6T1U
4.7 V ± 1.0%	S-1004CA47I-M5T1U	S-1004CA47I-I6T1U
4.8 V ± 1.0%	S-1004CA48I-M5T1U	S-1004CA48I-I6T1U
$4.9 \text{ V} \pm 1.0\%$	S-1004CA49I-M5T1U	S-1004CA49I-I6T1U
$5.0~V\pm1.0\%$	S-1004CA50I-M5T1U	S-1004CA50I-I6T1U

4.4 S-1004 Series CB type

Output form: CMOS output (Active "L")

Table 6		
Detection Voltage	SOT-23-5	
$1.0~V\pm22~mV$	S-1004CB10I-M5T1U	
$1.1 \text{ V} \pm 22 \text{ mV}$	S-1004CB11I-M5T1U	
$1.2 \text{ V} \pm 22 \text{ mV}$	S-1004CB12I-M5T1U	
1.3 V ± 22 mV	S-1004CB13I-M5T1U	
1.4 V ± 22 mV	S-1004CB14I-M5T1U	
1.5 V ± 22 mV	S-1004CB15I-M5T1U	
1.6 V ± 22 mV	S-1004CB16I-M5T1U	
1.7 V ± 22 mV	S-1004CB17I-M5T1U	
1.8 V ± 22 mV	S-1004CB18I-M5T1U	
$1.9 \text{ V} \pm 22 \text{ mV}$	S-1004CB19I-M5T1U	
$2.0~V\pm22~mV$	S-1004CB20I-M5T1U	
$2.1~V\pm22~mV$	S-1004CB21I-M5T1U	
$2.2~V\pm1.0\%$	S-1004CB22I-M5T1U	
$2.3~V\pm1.0\%$	S-1004CB23I-M5T1U	
$2.4~\text{V}\pm1.0\%$	S-1004CB24I-M5T1U	
$2.5~V\pm1.0\%$	S-1004CB25I-M5T1U	
$2.6~V\pm1.0\%$	S-1004CB26I-M5T1U	
$2.7~V\pm1.0\%$	S-1004CB27I-M5T1U	
$2.8~V\pm1.0\%$	S-1004CB28I-M5T1U	
$2.9~V\pm1.0\%$	S-1004CB29I-M5T1U	
$3.0~V\pm1.0\%$	S-1004CB30I-M5T1U	
$3.1~V\pm1.0\%$	S-1004CB31I-M5T1U	
$3.2~V\pm1.0\%$	S-1004CB32I-M5T1U	
$3.3~V\pm1.0\%$	S-1004CB33I-M5T1U	
$3.4~V\pm1.0\%$	S-1004CB34I-M5T1U	
$3.5~V\pm1.0\%$	S-1004CB35I-M5T1U	
$3.6~V\pm1.0\%$	S-1004CB36I-M5T1U	
3.7 V ± 1.0%	S-1004CB37I-M5T1U	
3.8 V ± 1.0%	S-1004CB38I-M5T1U	
3.9 V ± 1.0%	S-1004CB39I-M5T1U	
$4.0 \text{ V} \pm 1.0\%$	S-1004CB40I-M5T1U	
$4.1 \text{ V} \pm 1.0\%$	S-1004CB41I-M5T1U	
$4.2 \text{ V} \pm 1.0\%$	S-1004CB42I-M5T1U	
$4.3~V\pm1.0\%$	S-1004CB43I-M5T1U	
$4.4~V\pm1.0\%$	S-1004CB44I-M5T1U	
$4.5~V\pm1.0\%$	S-1004CB45I-M5T1U	
$4.6~V\pm1.0\%$	S-1004CB46I-M5T1U	
4.7 V ± 1.0%	S-1004CB47I-M5T1U	
$4.8~V\pm1.0\%$	S-1004CB48I-M5T1U	
$4.9~V\pm1.0\%$	S-1004CB49I-M5T1U	
$5.0 \text{ V} \pm 1.0\%$	S-1004CB50I-M5T1U	

Pin Configurations

1. S-1004 Series NA / CA type

1.1 SOT-23-5



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Figure 3

1.2 SNT-6A



Figure 4

Pin No.	Symbol	Description
1	OUT	Voltage detection output pin
2	VDD	Power supply pin
3	VSS	GND pin
4	CD	Connection pin for delay capacitor
5	SENSE	Detection voltage input pin

Table 7 Pin Configuration A

Pin No.	Symbol	Description	
1	OUT	Voltage detection output pin	
2	VDD	Power supply pin	
3	SENSE	Detection voltage input pin	
4	CD	Connection pin for delay capacitor	
5	NC ^{*1}	No connection	
6	VSS	GND pin	

Table 8 Pin Configuration A

*1. The NC pin is electrically open.

The NC pin can be connected to the VDD pin or the VSS pin.

2. S-1004 Series NB / CB type

2.1 SOT-23-5

Top view



Figure 5

Table 9 Pin Configuration B

Pin No.	Symbol	Description
1	OUT	Voltage detection output pin
2	VSS	GND pin
3	VDD	Power supply pin
4	SENSE	Detection voltage input pin
5	CD	Connection pin for delay capacitor

Absolute Maximum Ratings

Table 10

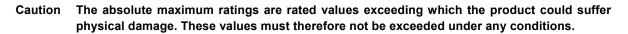
			(Ta = +25°C unless otherwise specified)			
	Item	Symbol	Absolute Maximum Rating	Unit		
Power supply vo	oltage	$V_{\text{DD}} - V_{\text{SS}}$	12.0	V		
CD pin input vol	tage	V _{CD}	$V_{SS}-0.3$ to $V_{DD}+0.3$	V		
SENSE pin inpu	t voltage	V _{SENSE}	V _{SS} – 0.3 to 12.0	V		
Output	Nch open-drain output product	V	V _{SS} – 0.3 to 12.0	V		
Output voltage	CMOS output product	V _{OUT}	$V_{\text{SS}} - 0.3$ to $V_{\text{DD}} + 0.3$	V		
Output current		I _{OUT}	50	mA		
Dowor dissinctio	SOT-23-5		600 ^{*1}	mW		
Power dissipation	SNT-6A	P _D	400 ^{*1}	mW		
Operation ambient temperature		T _{opr}	-40 to +85	°C		
Storage temperature		T _{stg}	-40 to +125	°C		

*1. When mounted on board

[Mounted board]

(1) Board size: 114.3 mm \times 76.2 mm \times t1.6 mm

(2) Name: JEDEC STANDARD51-7



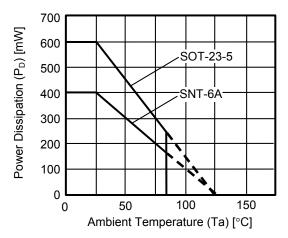


Figure 6 Power Dissipation of Package (When Mounted on Board)

Electrical Characteristics

1. Nch open-drain output product

Table 11

				(Ta =	+25°C u	nless oth	erwise s	pecified)
Item	Symbol	Cor	ndition	Min.	Тур.	Max.	Unit	Test Circuit
- *1		$0.95~V \leq V_{\text{DD}} \leq 10.0~V$	$1.0~V \leq -V_{DET(S)} < 2.2~V$	$\begin{array}{l} -V_{\text{DET}(S)} \\ - \ 0.022 \end{array}$	$-V_{\text{DET}(S)}$	$\begin{array}{l} -V_{\text{DET}(S)} \\ + \ 0.022 \end{array}$	V	1
Detection voltage ^{*1}	-VDET		$2.2~V \leq -V_{DET(S)} \leq 5.0~V$	$\begin{array}{c} -V_{\text{DET}(S)} \\ \times \ 0.99 \end{array}$	$-V_{\text{DET}(S)}$	$\begin{array}{c} -V_{\text{DET(S)}} \\ \times \ 1.01 \end{array}$	V	1
Hysteresis width	V _{HYS}		_	$-V_{DET} \times 0.03$	$-V_{DET} \times 0.05$	$-V_{DET} \times 0.07$	V	1
Current consumption ^{*2}	I _{SS}	V _{DD} = 10.0 V, V _{SENSE} =	$V = -V_{DET(S)} + 1.0 V$	_	0.50	0.90	μA	2
	V _{DD}		_	0.95	_	10.0	V	1
Output current	lout	Output transistor Nch $V_{DS}^{*3} = 0.5 V$ $V_{SENSE} = 0.0 V$	$V_{DD} = 0.95 V$ $V_{DD} = 1.2 V$ $V_{DD} = 2.4 V$ $V_{DD} = 4.8 V$	0.59 0.73 1.47 1.86	1.00 1.33 2.39 2.50	_ _ _	mA mA mA	3 3 3 3
Leakage current	Ileak	$V_{SENSE} = 0.0 V$ V _{DD} = 4.8 V Output transistor Nch V _{DD} = 10.0 V, V _{DS} ^{*3} = 10.0 V, V _{SENSE} = 10.0 V		-	-	_ 0.08	mA μA	3
Detection voltage temperature coefficient ^{*4}	$\frac{\Delta - V_{DET}}{\Delta Ta \bullet - V_{DET}}$	Ta = -40°C to +85°C		_	±100	±350	ppm/°C	1
Detection delay time ^{*5}	t _{DET}	V _{DD} = 5.0 V		_	40	-	μS	4
Release delay time ^{*6}	t _{RESET}	$V_{DD} = -V_{DET(S)} + 1.0 \text{ V}, \text{ C}_{D} = 4.7 \text{ nF}$		10.79	12.69	14.59	ms	4
SENSE pin resistance	R _{SENSE}	$\label{eq:linear} \begin{split} & 1.0 \ V \leq -V_{DET(S)} < 1.2 \ V \\ & 1.2 \ V \leq -V_{DET(S)} \leq 5.0 \ V \end{split}$		5.0 6.0	19.0 30.0	42.0 98.0	MΩ MΩ	2 2

*1. -V_{DET}: Actual detection voltage value, -V_{DET(S)}: Set detection voltage value (the center value of the detection voltage range in **Table 3** or **Table 4**)

*2. The current flowing through the SENSE pin resistance is not included.

- *3. V_{DS}: Drain-to-source voltage of the output transistor
- *4. The temperature change of the detection voltage [mV/°C] is calculated by using the following equation.

$$\frac{\Delta - V_{DET}}{\Delta Ta} \left[mV/^{\circ}C \right]^{*1} = -V_{DET(S)} (typ.) \left[V \right]^{*2} \times \frac{\Delta - V_{DET}}{\Delta Ta \bullet - V_{DET}} \left[ppm/^{\circ}C \right]^{*3} \div 1000$$

- *1. Temperature change of the detection voltage
- ***2.** Set detection voltage
- ***3.** Detection voltage temperature coefficient
- *5. The time period from when the pulse voltage of 6.0 V $\rightarrow -V_{DET(S)} 2.0$ V or 0 V is applied to the SENSE pin to when V_{OUT} reaches V_{DD} / 2, after the output pin is pulled up to 5.0 V by the resistance of 470 k Ω .
- *6. The time period from when the pulse voltage of 0.95 V \rightarrow 10.0 V is applied to the SENSE pin to when V_{OUT} reaches V_{DD} × 90%, after the output pin is pulled up to V_{DD} by the resistance of 100 kΩ.

BUILT-IN DELAY CIRCUIT (EXTERNAL DELAY TIME SETTING) VOLTAGE DETECTOR WITH SENSE PIN Rev.2.1_02 S-1004 Series

Table 12

2. CMOS output product

				(Ta =	- +25°C u	nless othe	erwise sp	pecified)
Item	Symbol	Condition		Min.	Тур.	Max.	Unit	Test Circuit
			$1.0~V \leq -V_{\text{DET}(S)} < 2.2~V$	$\begin{array}{l} -V_{\text{DET}(S)} \\ - \ 0.022 \end{array}$	$-V_{\text{DET}(S)}$	$\begin{array}{l} -V_{\text{DET}(S)} \\ + \ 0.022 \end{array}$	V	1
Detection voltage ^{*1}	-V _{DET}	$0.95~V \leq V_{DD} \leq 10.0~V$	$2.2~V \leq -V_{\text{DET}(S)} \leq 5.0~V$	$\begin{array}{c} -V_{\text{DET}(S)} \\ \times \ 0.99 \end{array}$	$-V_{\text{DET}(S)}$	$\begin{array}{c} -V_{\text{DET}(S)} \\ \times \ 1.01 \end{array}$	V	1
Hysteresis width	V _{HYS}		_	$-V_{DET} \times 0.03$	$-V_{DET} \times 0.05$	$-V_{DET} \times 0.07$	V	1
Current consumption ^{*2}	I _{SS}	V _{DD} = 10.0 V, V _{SENSE} =	V_{DD} = 10.0 V, V_{SENSE} = $-V_{DET(S)}$ + 1.0 V		0.50	0.90	μA	2
	V _{DD}		_	0.95	_	10.0	V	1
	Iout Iout $V_{DS}^{*3} = 0.5 V$ $V_{SENSE} = 0.0 V$ $V_{Output transistor}$ Pch $V_{DS}^{*3} = 0.5 V$ $V_{SENSE} = 10.0 V$	Nch	V _{DD} = 0.95 V	0.59	1.00	-	mA	3
Output current			V _{DD} = 1.2 V	0.73	1.33	-	mA	3
		V _{DS} ^{*3} = 0.5 V	V _{DD} = 2.4 V	1.47	2.39	-	mA	3
		V_{SENSE} = 0.0 V	V _{DD} = 4.8 V	1.86	2.50	-	mA	3
		•	V _{DD} = 4.8 V	1.62	2.60	-	mA	5
		V _{DD} = 6.0 V	1.78	2.86	-	mA	5	
Detection voltage temperature coefficient ^{*4}	Δ-V _{DET} ΔTa • -V _{DET}	'Ta = −40°C to +85°C		_	±100	±350	ppm/°C	1
Detection delay time ^{*5}	t _{DET}	V _{DD} = 5.0 V		_	40	_	μS	4
Release delay time ^{*6}	t _{RESET}	$V_{DD} = -V_{DET(S)} + 1.0 \text{ V}, C_D = 4.7 \text{ nF}$		10.79	12.69	14.59	ms	4
SENSE pin	P	$1.0 V \le -V_{DET(S)} < 1.2 V_{DET(S)}$	V	5.0	19.0	42.0	MΩ	2
resistance	R _{SENSE}	$1.2 \text{ V} \leq -V_{\text{DET}(S)} \leq 5.0 \text{ V}$		6.0	30.0	98.0	MΩ	2

*1. -V_{DET}: Actual detection voltage value, -V_{DET(S)}: Set detection voltage value (the center value of the detection voltage range in **Table 5** or **Table 6**)

*2. The current flowing through the SENSE pin resistance is not included.

*3. V_{DS}: Drain-to-source voltage of the output transistor

*4. The temperature change of the detection voltage [mV/°C] is calculated by using the following equation.

$$\frac{\Delta - V_{\text{DET}}}{\Delta \text{Ta}} \left[\text{mV/}^{\circ}\text{C} \right]^{*1} = -V_{\text{DET}(S)} (\text{typ.}) \left[\text{V} \right]^{*2} \times \frac{\Delta - V_{\text{DET}}}{\Delta \text{Ta} \bullet - V_{\text{DET}}} \left[\text{ppm/}^{\circ}\text{C} \right]^{*3} \div 1000$$

- *1. Temperature change of the detection voltage
- *2. Set detection voltage
- ***3.** Detection voltage temperature coefficient
- *5. The time period from when the pulse voltage of 6.0 V $\rightarrow -V_{DET(S)} 2.0$ V or 0 V is applied to the SENSE pin to when V_{OUT} reaches V_{DD} / 2.
- *6. The time period from when the pulse voltage of 0.95 V \rightarrow 10.0 V is applied to the SENSE pin to when V_{OUT} reaches V_{DD} × 90%.

BUILT-IN DELAY CIRCUIT (EXTERNAL DELAY TIME SETTING) VOLTAGE DETECTOR WITH SENSE PIN S-1004 Series Rev.2.1_02

Test Circuits

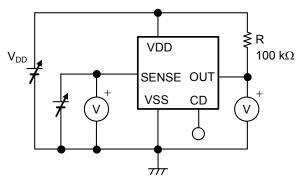


Figure 7 Test Circuit 1 (Nch open-drain output product)

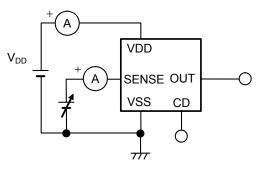


Figure 9 Test Circuit 2

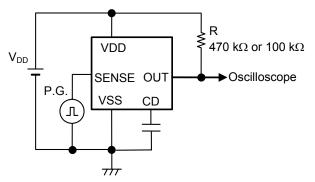
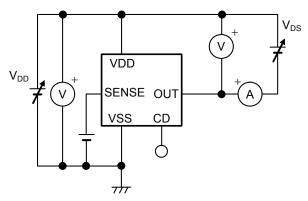


Figure 11 Test Circuit 4 (Nch open-drain output product)





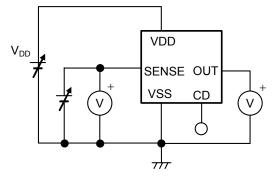


Figure 8 Test Circuit 1 (CMOS output product)

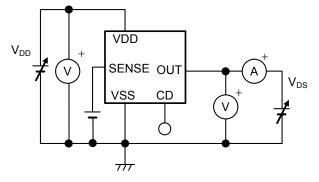


Figure 10 Test Circuit 3

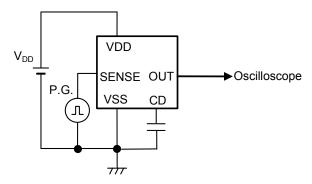
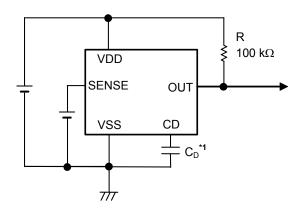


Figure 12 Test Circuit 4 (CMOS output product)

Standard Circuits

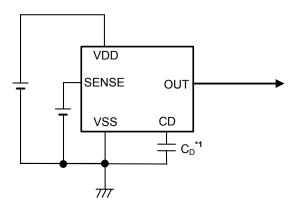
1. Nch open-drain output product



*1. The delay capacitor (C_D) should be connected directly to the CD pin and the VSS pin.

Figure 14

2. CMOS output product



*1. The delay capacitor (C_D) should be connected directly to the CD pin and the VSS pin.

Figure 15

Caution The above connection diagram and constant will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constant.

Explanation of Terms

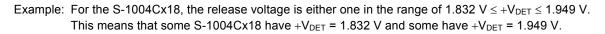
1. Detection voltage (–V_{DET})

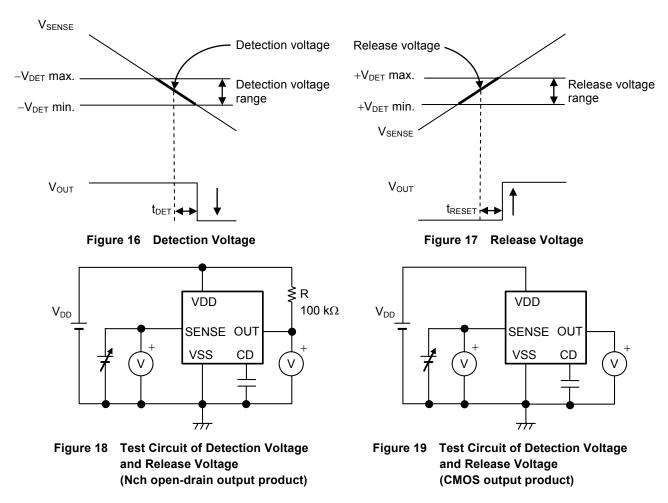
The detection voltage is a voltage at which the output in **Figure 18** or **Figure 19** turns to "L". The detection voltage varies slightly among products of the same specification. The variation of detection voltage between the specified minimum ($-V_{DET}$ min.) and the maximum ($-V_{DET}$ max.) is called the detection voltage range (Refer to **Figure 16**).

Example: In the S-1004Cx18, the detection voltage is either one in the range of 1.778 V $\leq -V_{DET} \leq 1.822$ V. This means that some S-1004Cx18 have $-V_{DET} = 1.778$ V and some have $-V_{DET} = 1.822$ V.

2. Release voltage (+V_{DET})

The release voltage is a voltage at which the output in **Figure 18** or **Figure 19** turns to "H". The release voltage varies slightly among products of the same specification. The variation of release voltage between the specified minimum ($+V_{DET}$ min.) and the maximum ($+V_{DET}$ max.) is called the release voltage range (Refer to **Figure 17**). The range is calculated from the actual detection voltage ($-V_{DET}$) of a product and is in the range of $-V_{DET} \times 1.03 \le +V_{DET} \le -V_{DET} \times 1.07$.





3. Hysteresis width (V_{HYS})

The hysteresis width is the voltage difference between the detection voltage and the release voltage (the voltage at point B – the voltage at point A = V_{HYS} in "Figure 23 Timing Chart of S-1004 Series NA / NB Type" and "Figure 25 Timing Chart of S-1004 Series CA / CB Type"). Setting the hysteresis width between the detection voltage and the release voltage, prevents malfunction caused by noise on the input voltage.

4. Release delay time (t_{RESET})

The release delay time is the time period from when the input voltage to the SENSE pin exceeds the release voltage ($+V_{DET}$) to when the output from the OUT pin inverts. The release delay time changes according to the delay capacitor (C_D).

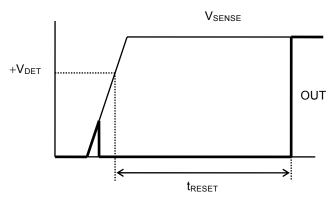


Figure 20 Release Delay Time

5. Feed-through current

The feed-through current is a current that flows instantaneously to the VDD pin at the time of detection and release of a voltage detector. The feed-through current is large in CMOS output product, small in Nch open-drain output product.

6. Oscillation

In applications where an input resistor is connected (**Figure 21**), taking a CMOS output (active "L") product for example, the feed-through current which is generated when the output goes from "L" to "H" (at the time of release) causes a voltage drop equal to [feed-through current] \times [input resistance]. Since the VDD pin and the SENSE pin are shorted as in **Figure 21**, the SENSE pin voltage drops at the time of release. Then the SENSE pin voltage drops below the detection voltage and the output goes from "H" to "L". In this status, the feed-through current stops and its resultant voltage drop disappears, and the output goes from "L" to "H". The feed-through current is then generated again, a voltage drop appears, and repeating the process finally induces oscillation.

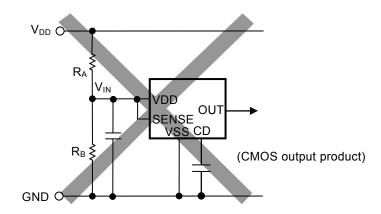


Figure 21 Example for Bad Implementation Due to Detection Voltage Change

Operation

1. Basic operation

1.1 S-1004 Series NA / NB type

(1) When the power supply voltage (V_{DD}) is the minimum operation voltage or higher, and the SENSE pin voltage (V_{SENSE}) is the release voltage ($+V_{DET}$) or higher, the Nch transistor is turned off to output V_{DD} ("H") when the output is pulled up. Since the Nch transistor (N1) is turned off, the input voltage to the comparator is ($R_B + R_C$) • V_{SENSE}

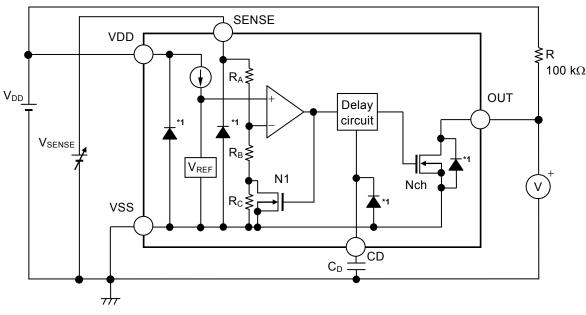
```
R_A + R_B + R_C
```

(2) Even if V_{SENSE} decreases to $+V_{DET}$ or lower, V_{DD} is output when V_{SENSE} is higher than the detection voltage ($-V_{DET}$).

When V_{SENSE} decreases to $-V_{\text{DET}}$ or lower (point A in **Figure 23**), the Nch transistor is turned on. And then V_{SS} ("L") is output from the OUT pin after the elapse of the detection delay time (t_{DET}).

At this time, N1 is turned on, and the input voltage to the comparator is $\frac{R_B \bullet V_{SENSE}}{R_A + R_B}$

- (3) Even if V_{SENSE} further decreases to the IC's minimum operation voltage or lower, the output from the OUT pin is stable when V_{DD} is minimum operation voltage or higher.
- (4) Even if V_{SENSE} exceeds $-V_{DET}$, V_{SS} is output when V_{SENSE} is lower than $+V_{DET}$.
- (5) When V_{SENSE} increases to +V_{DET} or higher (point B in **Figure 23**), the Nch transistor is turned off. And then V_{DD} is output from the OUT pin after the elapse of the release delay time (t_{RESET}) when the output is pulled up.



***1.** Parasitic diode

Figure 22 Operation of S-1004 Series NA / NB Type

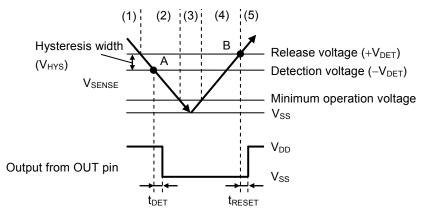


Figure 23 Timing Chart of S-1004 Series NA / NB Type

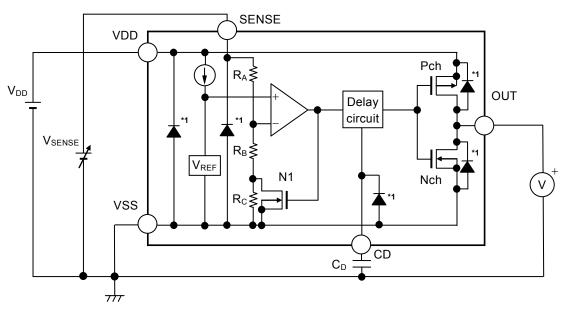
1. 2 S-1004 Series CA / CB type

- (1) When the power supply voltage (V_{DD}) is the minimum operation voltage or higher, and the SENSE pin voltage (V_{SENSE}) is the release voltage (+V_{DET}) or higher, the Nch transistor is turned off and the Pch transistor is turned on to output V_{DD} ("H"). Since the Nch transistor (N1) is turned off, the input voltage to the comparator is $(R_B + R_C) \bullet V_{SENSE}$.
 - $R_A + R_B + R_C$
- (2) Even if V_{SENSE} decreases to $+V_{DET}$ or lower, V_{DD} is output when V_{SENSE} is higher than the detection voltage $(-V_{DET})$.

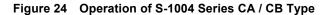
When V_{SENSE} decreases to $-V_{DET}$ or lower (point A in **Figure 25**), the Nch transistor is turned on and the Pch transistor is turned off. And then V_{SS} ("L") is output from the OUT pin after the elapse of the detection delay time (t_{DET}).

At this time, N1 is turned on, and the input voltage to the comparator is $\frac{R_B \bullet V_{SENSE}}{R_A + R_B}$.

- (3) Even if V_{SENSE} further decreases to the IC's minimum operation voltage or lower, the output from the OUT pin is stable when V_{DD} is minimum operation voltage or higher.
- (4) Even if V_{SENSE} exceeds $-V_{DET}$, V_{SS} is output when V_{SENSE} is lower than $+V_{DET}$.
- (5) When V_{SENSE} increases to +V_{DET} or higher (point B in Figure 25), the Nch transistor is turned off and the Pch transistor is turned on. And then V_{DD} is output from the OUT pin after the elapse of the release delay time (t_{RESET}).



***1.** Parasitic diode



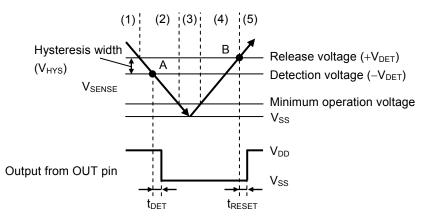


Figure 25 Timing Chart of S-1004 Series CA / CB Type

2. SENSE pin

2.1 Error when detection voltage is set externally

By connecting a node that was resistance-divided by the resistor (R_A) and the resistor (R_B) to the SENSE pin as seen in Figure 26, the detection voltage can be set externally.

For conventional products without the SENSE pin, RA cannot be too large since the resistance-divided node must be connected to the VDD pin. This is because a feed-through current will flow through the VDD pin when it goes from detection to release, and if R_A is large, problems such as oscillation or larger error in the hysteresis width may occur.

In the S-1004 Series, R_A and R_B are easily made larger since the resistance-divided node can be connected to the SENSE pin through which no feed-through current flows. However, be careful of error in the current flowing through the internal resistance (R_{SENSE}) that will occur.

Although R_{SENSE} in the S-1004 Series is large (5 MΩ min.) to make the error small, R_A and R_B should be selected such that the error is within the allowable limits.

2. 2 Selection of R_A and R_B

In Figure 26, the relation between the external setting detection voltage (V_{DX}) and the actual detection voltage (-V_{DET}) is ideally calculated by the equation below.

$$V_{DX} = -V_{DET} \times \left(1 + \frac{R_A}{R_B}\right) \qquad \cdots (1)$$

However, in reality there is an error in the current flowing through R_{SENSE}. When considering this error, the relation between V_{DX} and $-V_{DET}$ is calculated as follows.

$$V_{DX} = -V_{DET} \times \left(1 + \frac{R_A}{R_B || R_{SENSE}}\right)$$
$$= -V_{DET} \times \left(1 + \frac{R_A}{\frac{R_B \times R_{SENSE}}{R_B + R_{SENSE}}}\right)$$
$$= -V_{DET} \times \left(1 + \frac{R_A}{R_B}\right) + \frac{R_A}{R_{SENSE}} \times -V_{DET} \qquad \cdots (2)$$

By using equations (1) and (2), the error is calculated as $-V_{DET} \times \frac{R_A}{R_{SENSE}}$.

The error rate is calculated as follows by dividing the error by the right-hand side of equation (1).

$$\frac{R_A \times R_B}{R_{SENSE} \times (R_A + R_B)} \times 100 \, [\%] = \frac{R_A \parallel R_B}{R_{SENSE}} \times 100 \, [\%] \qquad \cdots (3)$$

As seen in equation (3), the smaller the resistance values of R_A and R_B compared to R_{SENSE}, the smaller the error rate becomes.

Also, the relation between the external setting hysteresis width (V_{HX}) and the hysteresis width (V_{HYS}) is calculated by equation below. Error due to R_{SENSE} also occurs to the relation in a similar way to the detection voltage.

CD

$$V_{HX} = V_{HYS} \times \left(1 + \frac{R_A}{R_B}\right) \qquad \cdots (4)$$

$$V_{DX} = V_{DET} \qquad V_{DT} \qquad V_{DT$$

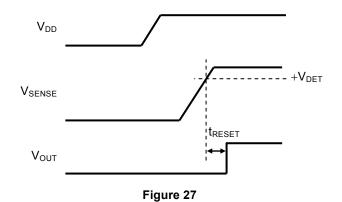
Figure 26 Detection Voltage External Setting Circuit

If R_A and R_B are large, the SENSE pin input impedance becomes higher and may cause a Caution malfunction due to noise. In this case, connect a capacitor between the SENSE pin and the VSS pin.

2.3 Power on sequence

Apply power in the order, the VDD pin then the SENSE pin.

As seen in **Figure 27**, when $V_{SENSE} \ge +V_{DET}$, the OUT pin output (V_{OUT}) rises and the S-1004 Series becomes the release status (normal operation).



Caution If power is applied in the order the SENSE pin then the VDD pin, an erroneous release may occur even if V_{SENSE} < +V_{DET}.

2.4 Precautions when shorting between the VDD pin and the SENSE pin

2.4.1 Input resistor

Do not connect the input resistor (R_A) when shorting between the VDD pin and the SENSE pin.

A feed-through current flows through the VDD pin at the time of release. When connecting the circuit shown as **Figure 28**, the feed-through current of the VDD pin flowing through R_A will cause a drop in V_{SENSE} at the time of release.

At that time, oscillation may occur if $V_{\text{SENSE}} \leq -V_{\text{DET}}$.

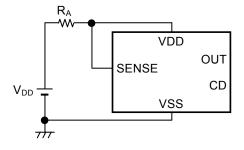


Figure 28

2.4.2 Parasitic resistance and parasitic capacitance

Due to the difference in parasitic resistance and parasitic capacitance of the VDD pin and the SENSE pin, power may be applied to the SENSE pin first.

Note that an erroneous release may occur if this happens (refer to "2.3 Power on sequence").

Caution In CMOS output product, make sure that the VDD pin input impedance does not become too high, regardless of the above. Since a feed-through current is large, a malfunction may occur if the VDD pin voltage changes greatly at the time of release.

2. 5 Malfunction when V_{DD} falls

As seen in Figure 29, note that if the VDD pin voltage (V_{DD}) drops steeply below 1.2 V when $-V_{DET} < V_{SENSE} < +V_{DET}$, erroneous detection may occur.

When $V_{DD\ Low} \geq 1.2$ V, erroneous detection does not occur.

When $V_{DD_Low} < 1.2$ V, the more the V_{DD} falling amplitude increases or the shorter the falling time becomes, the easier the erroneous detection.

Perform thorough evaluation in actual application.

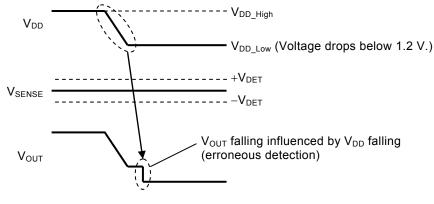
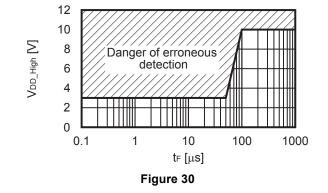
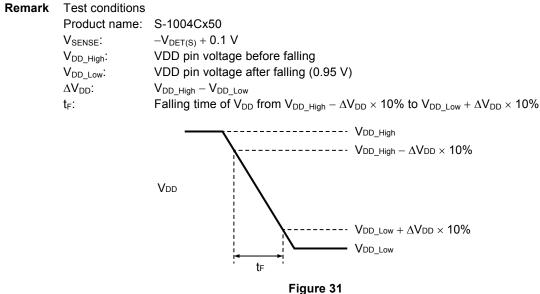


Figure 29

The S-1004Cx50 example in Figure 30 shows an example of erroneous detection boundary conditions.





3. Delay circuit

The delay circuit has the function that adjusts the release delay time (t_{RESET}) from when the SENSE pin voltage (V_{SENSE}) reaches release voltage ($+V_{DET}$) to when the output from OUT pin inverts.

 t_{RESET} is determined by the delay coefficient, the delay capacitor (C_D), and the release delay time when the CD pin is open (t_{RESET0}), and calculated by the equation below.

Table 13

 t_{RESET} [ms] = Delay coefficient × C_D [nF] + t_{RESET0} [ms]

Operation		Delay Coefficient	
Temperature	Min.	Тур.	Max.
Ta = +85°C	1.78	2.29	3.13
Ta = +25°C	2.30	2.66	3.07
Ta = -40°C	2.68	3.09	3.57

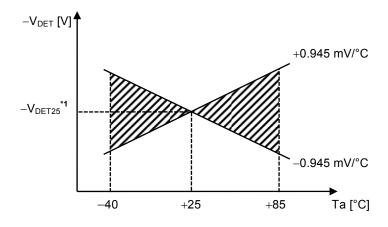
	т	able 14	
Operation	Release Delay Ti	me when CD Pin	is Open (t _{RESET0})
Temperature	Min.	Тур.	Max.
Ta = +85°C	0.020 ms	0.049 ms	0.130 ms
Ta = +25°C	0.021 ms	0.059 ms	0.164 ms
Ta = -40°C	0.024 ms	0.074 ms	0.202 ms

- Caution 1. Mounted board layout should be made in such a way that no current flows into or flows from the CD pin since the impedance of the CD pin is high, otherwise correct delay time cannot be provided.
 - 2. There is no limit for the capacitance of C_D as long as the leakage current of the capacitor can be ignored against the built-in constant current value (30 nA to 200 nA).
 - 3. The detection delay time (t_{DET}) cannot be adjusted by $C_{D.}$

4. Other characteristics

4.1 Temperature characteristics of detection voltage

The shaded area in **Figure 32** shows the temperature characteristics of detection voltage in the operation temperature range.



*1. $-V_{DET25}$ is a detection voltage value at Ta = +25°C.

Figure 32 Temperature Characteristics of Detection Voltage (Example for -V_{DET} = 2.7 V)

4. 2 Temperature characteristics of release voltage

The temperature change $\frac{\Delta + V_{\text{DET}}}{\Delta \text{Ta}}$ of the release voltage is calculated by using the temperature change $\frac{\Delta - V_{\text{DET}}}{\Delta \text{Ta}}$ of the detection voltage as follows:

 $\frac{\Delta + V_{\text{DET}}}{\Delta \text{Ta}} = \frac{+ V_{\text{DET}}}{-V_{\text{DET}}} \times \frac{\Delta - V_{\text{DET}}}{\Delta \text{Ta}}$

The temperature change of the release voltage and the detection voltage has the same sign consequently.

4.3 Temperature characteristics of hysteresis voltage

The temperature change of the hysteresis voltage is expressed as $\frac{\Delta + V_{DET}}{\Delta Ta} - \frac{\Delta - V_{DET}}{\Delta Ta}$ and is calculated as follows:

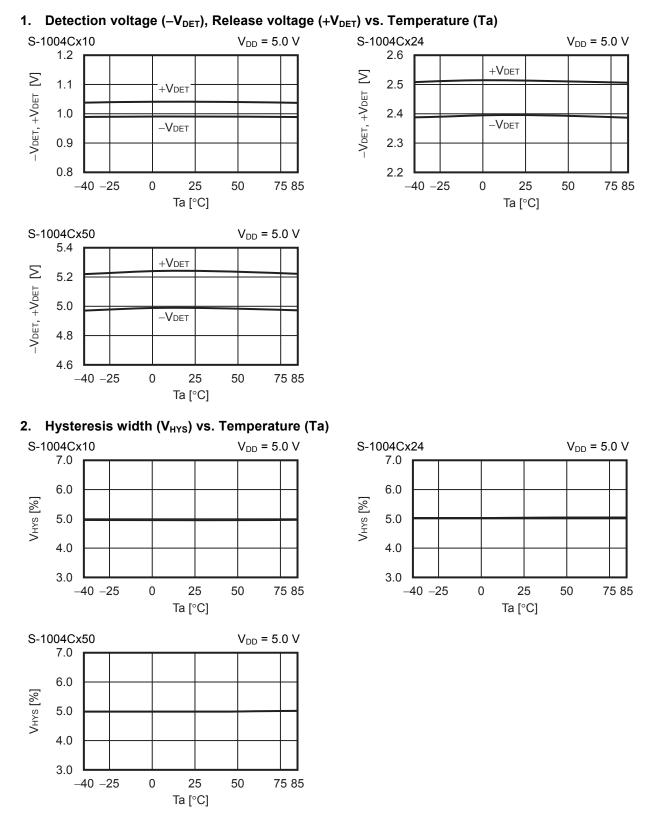
$$\frac{\Delta + V_{\text{DET}}}{\Delta \text{Ta}} - \frac{\Delta - V_{\text{DET}}}{\Delta \text{Ta}} = \frac{V_{\text{HYS}}}{-V_{\text{DET}}} \times \frac{\Delta - V_{\text{DET}}}{\Delta \text{Ta}}$$

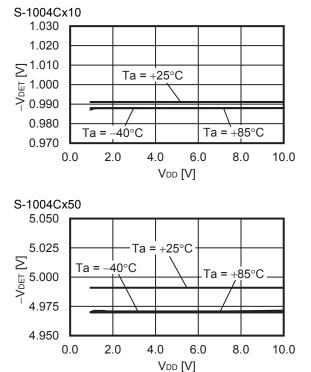
Precautions

- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- In CMOS output product of the S-1004 Series, the feed-through current flows at the time of detection and release. If the VDD pin input impedance is high, malfunction may occur due to the voltage drop by the feed-through current when releasing.
- In CMOS output product, oscillation may occur if a pull-down resistor is connected and falling speed of the SENSE pin voltage (V_{SENSE}) is slow near the detection voltage when the VDD pin and the SENSE pin are shorted.
- When designing for mass production using an application circuit described herein, the product deviation and temperature characteristics of the external parts should be taken into consideration. ABLIC Inc. shall not bear any responsibility for patent infringements related to products using the circuits described herein.
- ABLIC Inc. claims no responsibility for any disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

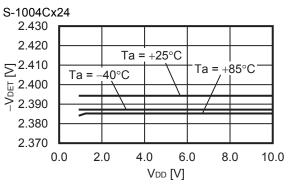
Rev.2.1 02







3. Detection voltage (-V_{DET}) vs. Power supply voltage (V_{DD})



4. Hysteresis width (V_{HYS}) vs. Power supply voltage (V_{DD})

5.0

4.0

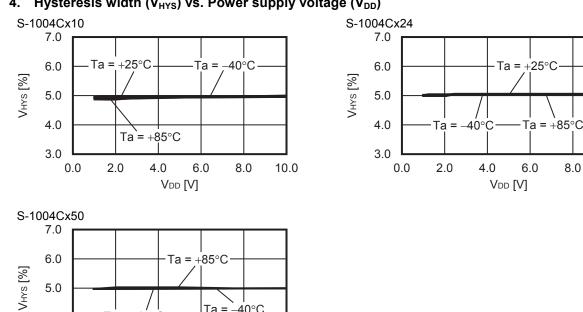
3.0 0.0 Ta = +25°C

4.0

6.0

Vdd [V]

2.0



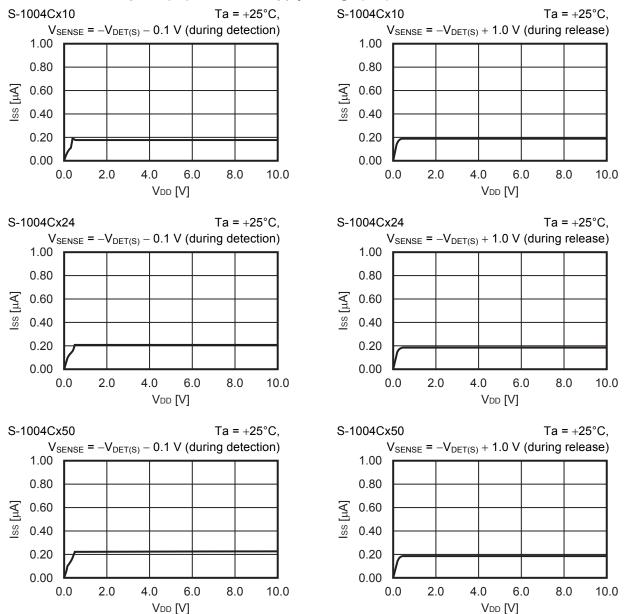
Ta = -40°C

8.0

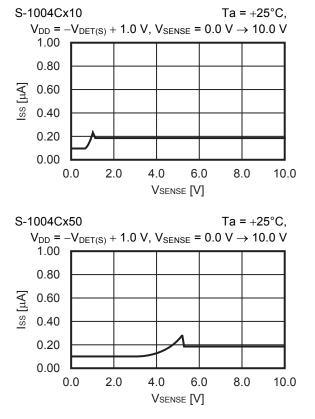
10.0

8.0

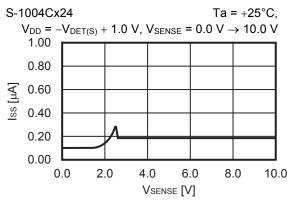
10.0



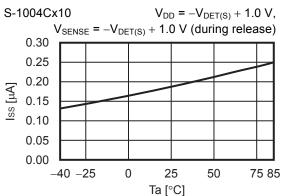
5. Current consumption (I_{SS}) vs. Power supply voltage (V_{DD})

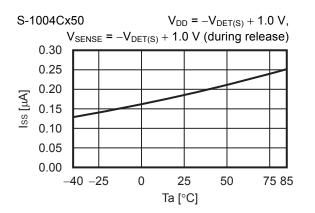


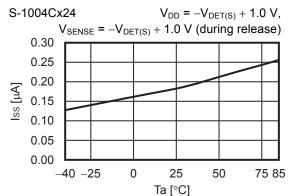
6. Current consumption (I_{SS}) vs. SENSE pin input voltage (V_{SENSE})



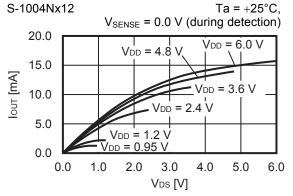
7. Current consumption (I_{ss}) vs. Temperature (Ta)

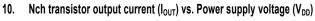


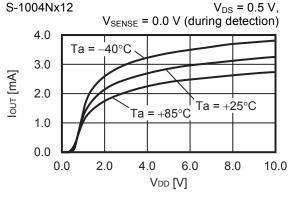




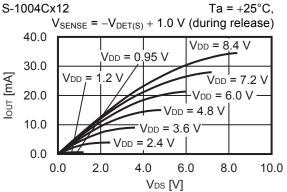
8. Nch transistor output current (I_{OUT}) vs. V_{DS}



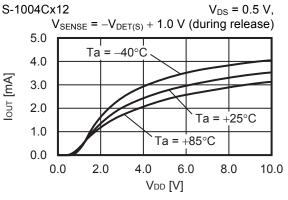




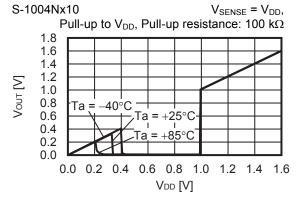
9. Pch transistor output current (I_{OUT}) vs. V_{DS}

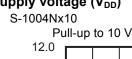


11. Pch transistor output current (I_{OUT}) vs. Power supply voltage (V_{DD})

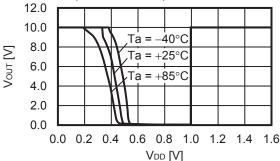


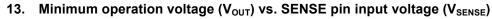
12. Minimum operation voltage (V_{OUT}) vs. Power supply voltage (V_{DD})

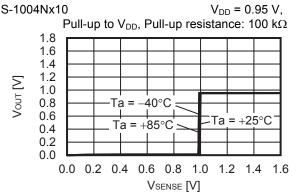


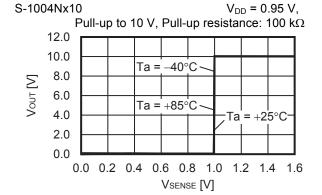


Nx10 $V_{\text{SENSE}} = V_{DD}$, Pull-up to 10 V, Pull-up resistance: 100 k Ω

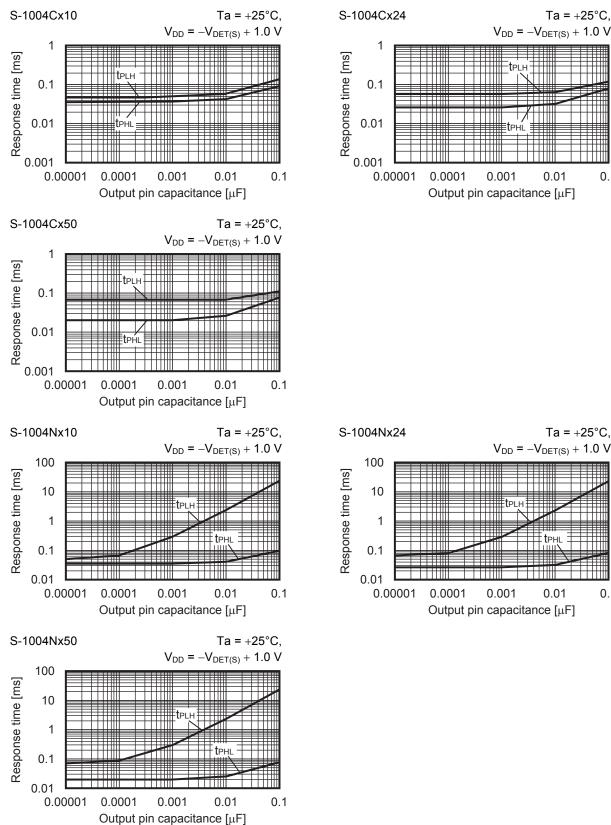








Remark V_{DS}: Drain-to-source voltage of the output transistor

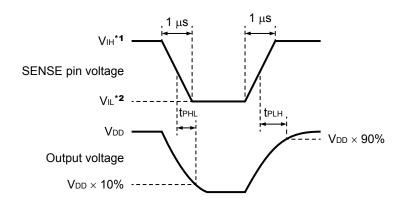


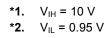
14. Dynamic response vs. Output pin capacitance (C_{OUT}) (CD pin; open)

0.1

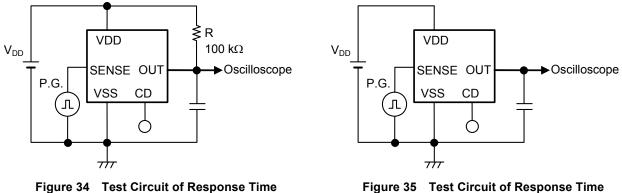
0.1

BUILT-IN DELAY CIRCUIT (EXTERNAL DELAY TIME SETTING) VOLTAGE DETECTOR WITH SENSE PIN S-1004 Series Rev.2.1_02









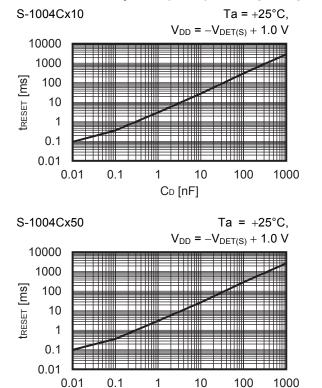
(Nch open-drain output product)

igure 35 Test Circuit of Response Time (CMOS output product)

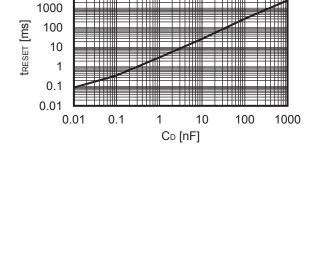
Caution The above connection diagram and constant will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constant.

S-1004Cx24

10000

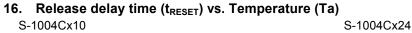


15. Release delay time (t_{RESET}) vs. CD pin capacitance (C_D) (Without output pin capacitance)

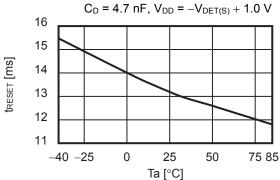


 $Ta = +25^{\circ}C,$

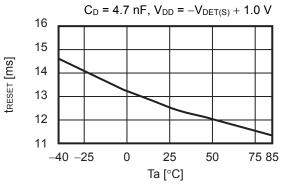
 $V_{DD} = -V_{DET(S)} + 1.0 V$

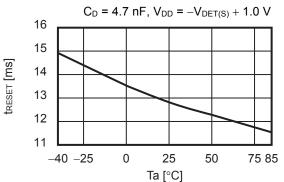


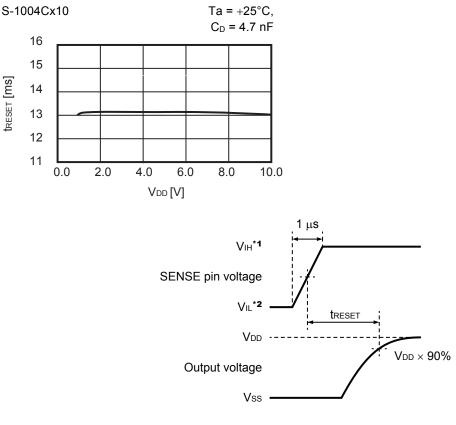
CD [nF]



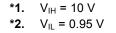
S-1004Cx50



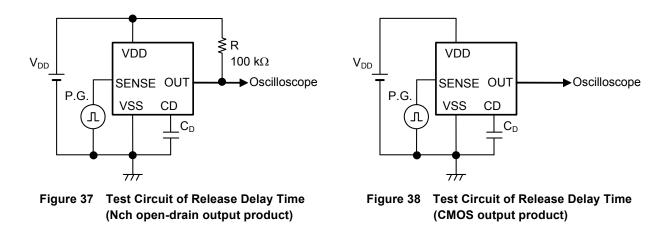




17. Release delay time (t_{RESET}) vs. Power supply voltage (V_{DD})







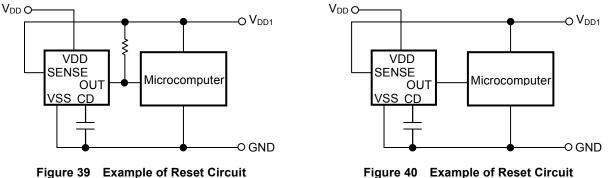
Caution The above connection diagram and constant will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constant.

Application Circuit Examples

1. Microcomputer reset circuits

In microcomputers, when the power supply voltage is lower than the minimum operation voltage, an unspecified operation may be performed or the contents of the memory register may be lost. When power supply voltage returns to the normal level, the microcomputer needs to be initialized. Otherwise, the microcomputer may malfunction after that. Reset circuits to protect microcomputer in the event of current being momentarily switched off or lowered.

Using the S-1004 Series which has the low minimum operation voltage, the high-accuracy detection voltage and the hysteresis width, reset circuits can be easily constructed as seen in **Figure 39** and **Figure 40**.



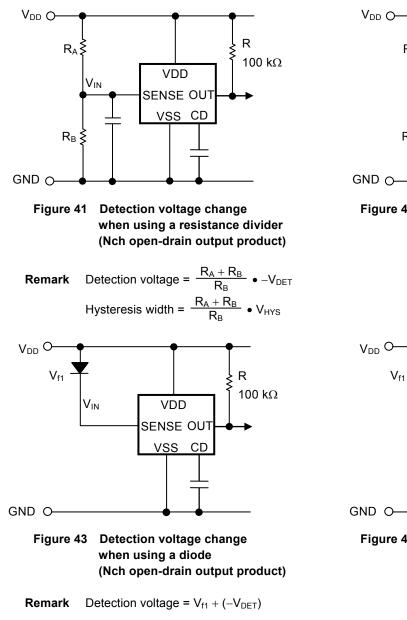
(CMOS output product)

(Nch open-drain output product)

Caution The above connection diagram and constant will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constant.

2. Change of detection voltage

If there is not a product with a specified detection voltage value in the S-1004 Series, the detection voltage can be changed by using a resistance divider or a diode, as seen in **Figure 41** to **Figure 44**. In **Figure 41** and **Figure 42**, hysteresis width also changes.



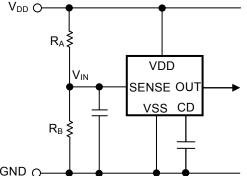
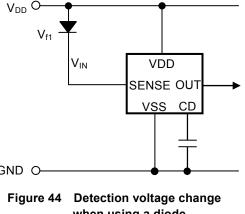
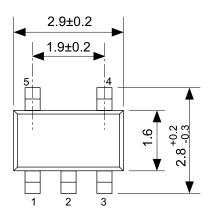


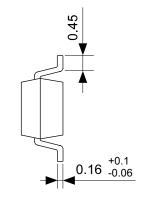
Figure 42 Detection voltage change when using a resistance divider (CMOS output product)

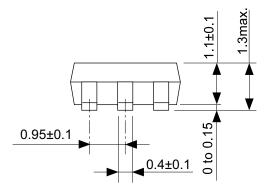


when using a diode (CMOS output product)

- Caution 1. The above connection diagram and constant will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constant.
 - 2. Set the constants referring to "2. 1 Error when detection voltage is set externally" in "■ Operation".

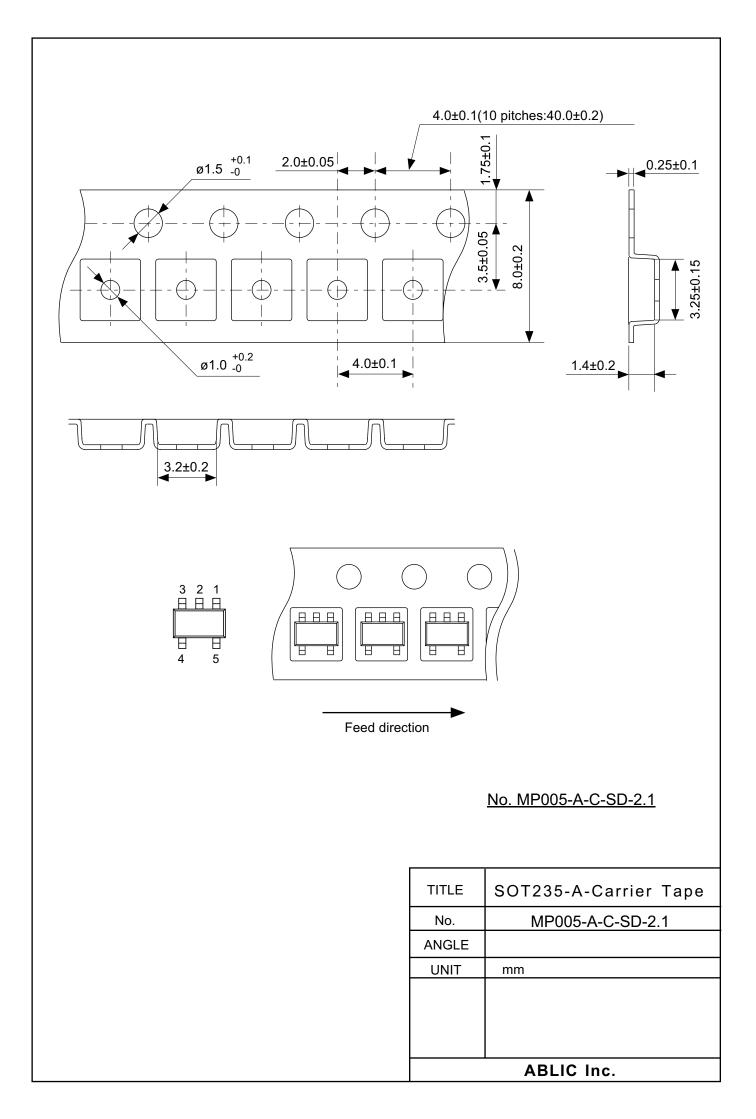


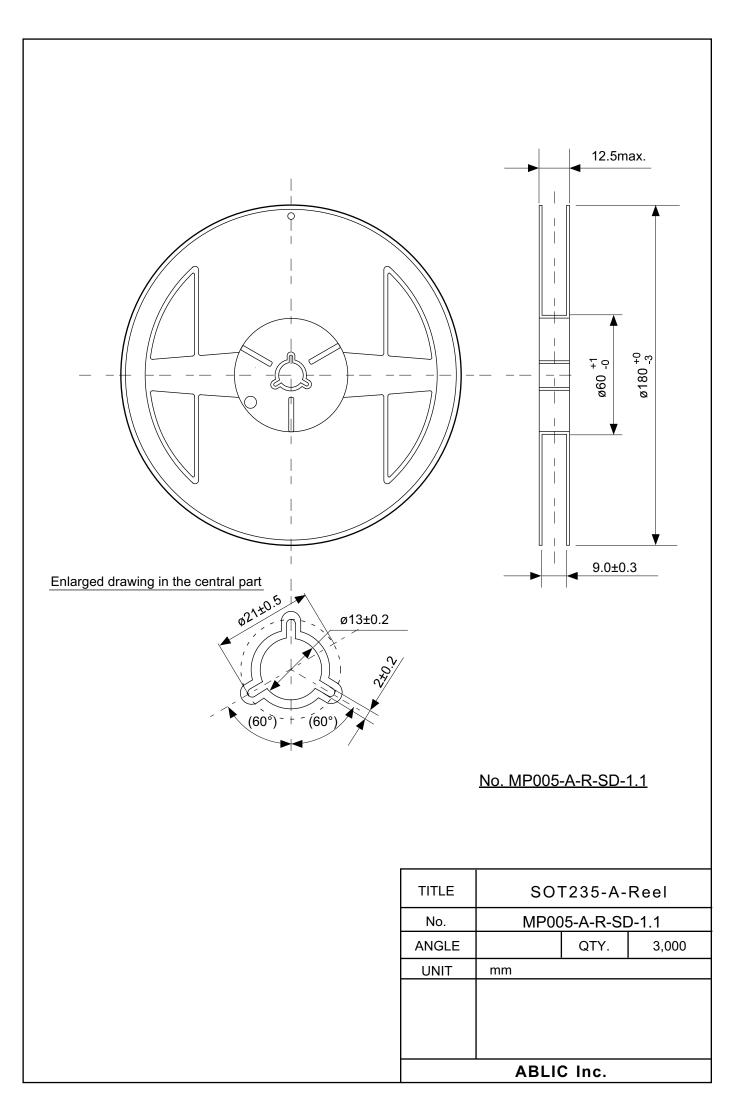


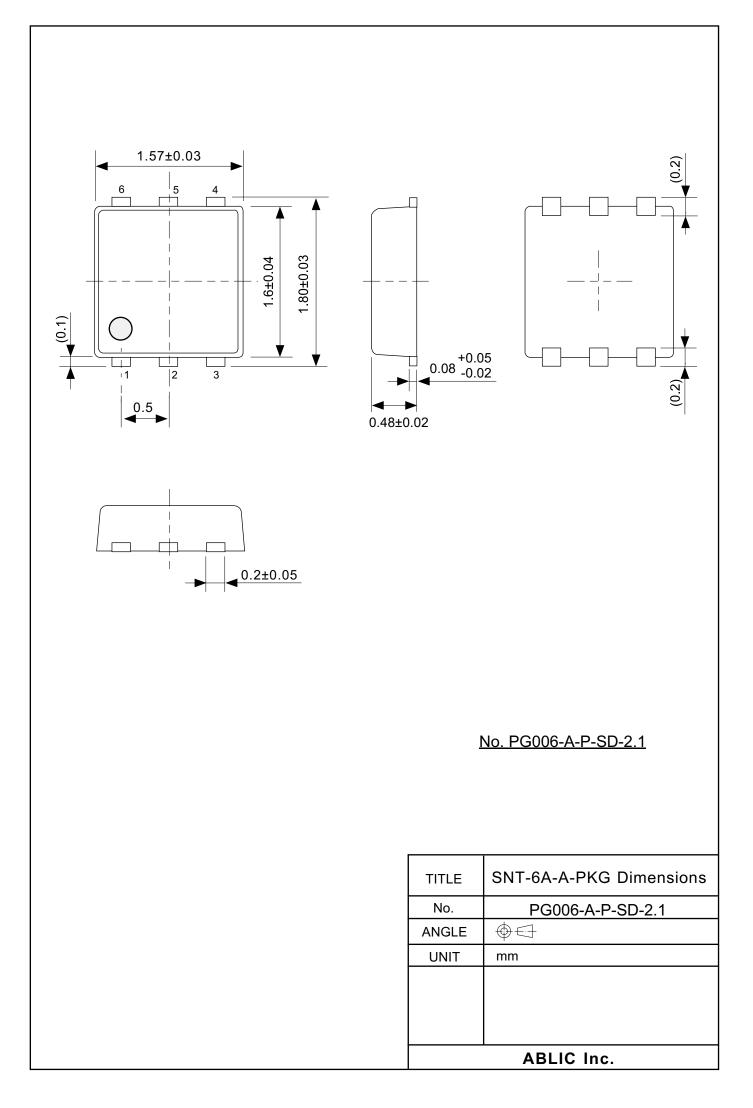


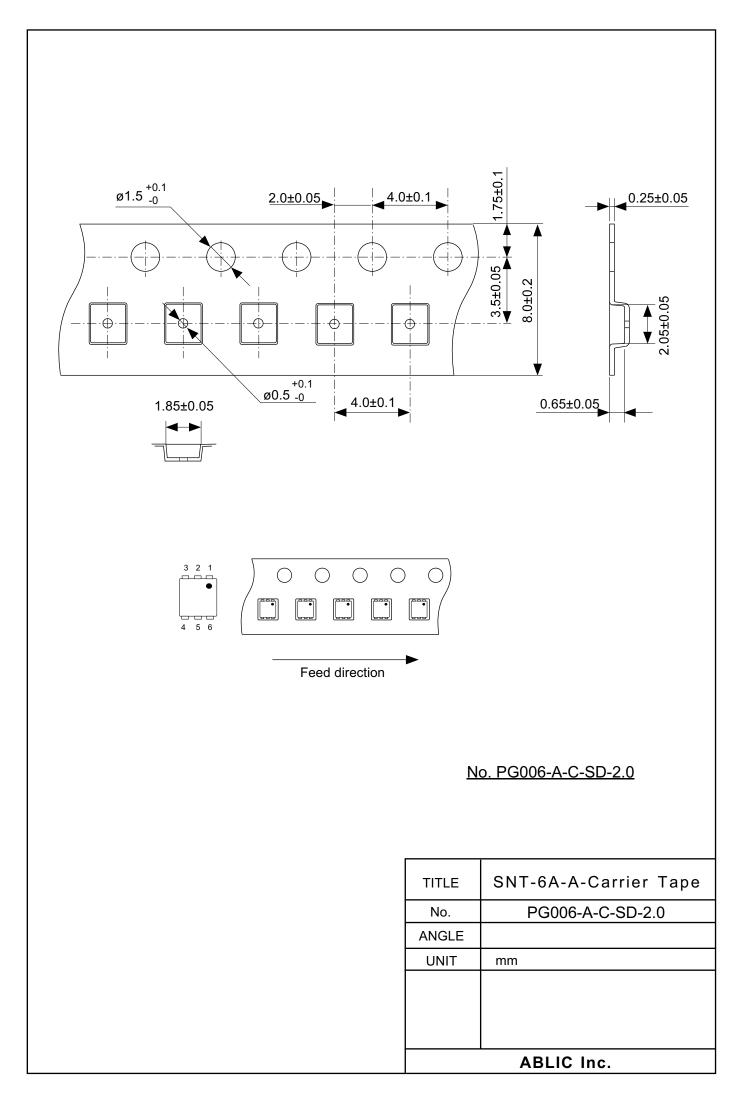
No. MP005-A-P-SD-1.3

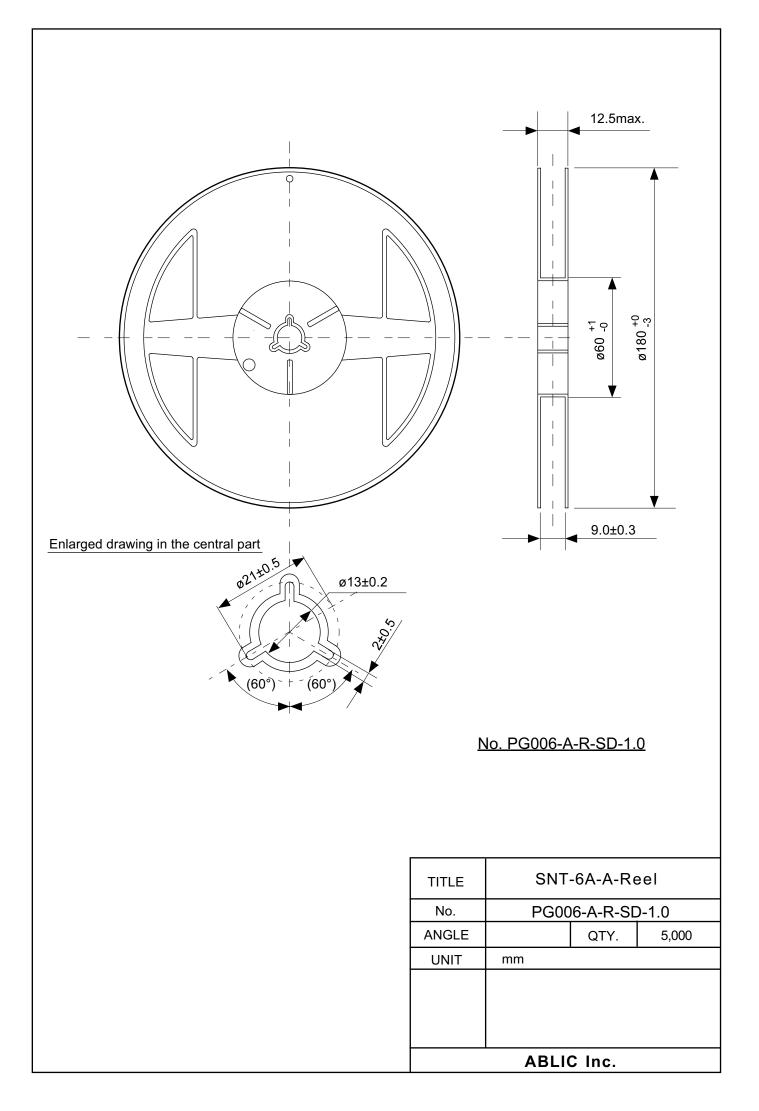
TITLE	SOT235-A-PKG Dimensions	
No.	MP005-A-P-SD-1.3	
ANGLE		
UNIT	mm	
ABLIC Inc.		

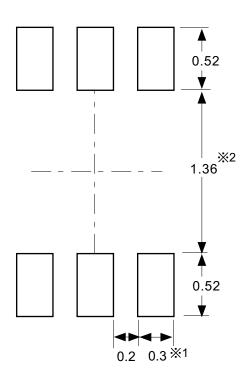












※1. ランドパターンの幅に注意してください (0.25 mm min. / 0.30 mm typ.)。 ※2. パッケージ中央にランドパターンを広げないでください (1.30 mm ~ 1.40 mm)。

- 注意 1. パッケージのモールド樹脂下にシルク印刷やハンダ印刷などしないでください。
 - 2. パッケージ下の配線上のソルダーレジストなどの厚みをランドパターン表面から0.03 mm 以下にしてください。
 - 3. マスク開ロサイズと開口位置はランドパターンと合わせてください。
 - 4. 詳細は "SNTパッケージ活用の手引き" を参照してください。

%1. Pay attention to the land pattern width (0.25 mm min. / 0.30 mm typ.).

%2. Do not widen the land pattern to the center of the package (1.30 mm ~ 1.40 mm).

- Caution 1. Do not do silkscreen printing and solder printing under the mold resin of the package.
 2. The thickness of the solder resist on the wire pattern under the package should be 0.03 mm or less from the land pattern surface.
 - 3. Match the mask aperture size and aperture position with the land pattern.
 - 4. Refer to "SNT Package User's Guide" for details.
- ※1. 请注意焊盘模式的宽度 (0.25 mm min. / 0.30 mm typ.)。
- ※2. 请勿向封装中间扩展焊盘模式 (1.30 mm~1.40 mm)。
- 注意 1. 请勿在树脂型封装的下面印刷丝网、焊锡。
 - 2. 在封装下、布线上的阻焊膜厚度 (从焊盘模式表面起) 请控制在 0.03 mm 以下。
 - 3. 钢网的开口尺寸和开口位置请与焊盘模式对齐。
 - 4. 详细内容请参阅 "SNT 封装的应用指南"。

TITLE	SNT-6A-A -Land Recommendation	
No.	PG006-A-L-SD-4.1	
ANGLE		
UNIT	mm	
ABLIC Inc.		

No. PG006-A-L-SD-4.1

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- 10. The products are not designed to be radiation-proof. The necessary radiation measures should be taken in the product design by the customer depending on the intended use.
- 11. The products do not affect human health under normal use. However, they contain chemical substances and heavy metals and should therefore not be put in the mouth. The fracture surfaces of wafers and chips may be sharp. Be careful when handling these with the bare hands to prevent injuries, etc.
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